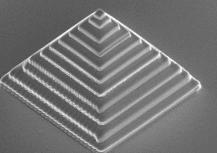
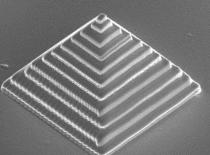


Building with DualBeamTM



高海峰 FEI 公司 应用工程师





Content

- DualBeam™ 基础
- FIB 纳米加工应用案例/技术介绍
- FEI Company



DualBeamTM 基础

Q: What is DualBeamTM

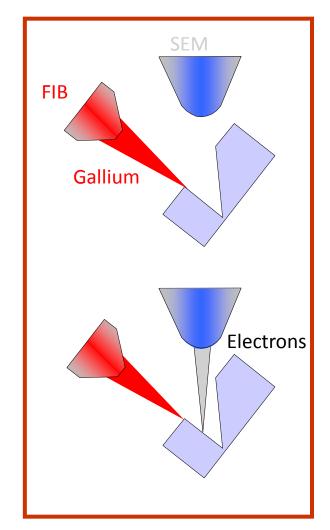


What is a DualBeamTM?

SEM: **S**canning **E**lectron **M**icroscope

FIB: Focus Ion Beam







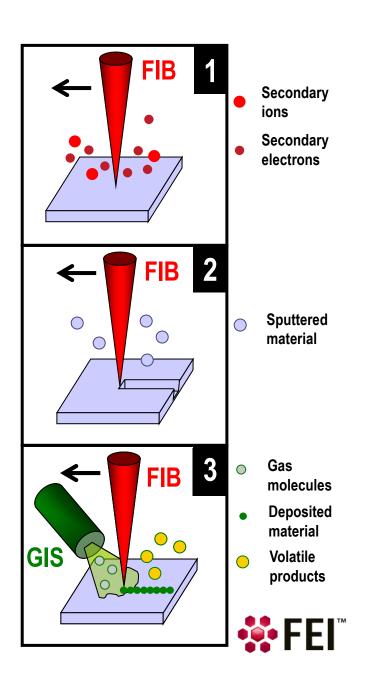
FIB: 三个基本的工作方式

Source: 金属镓Ga

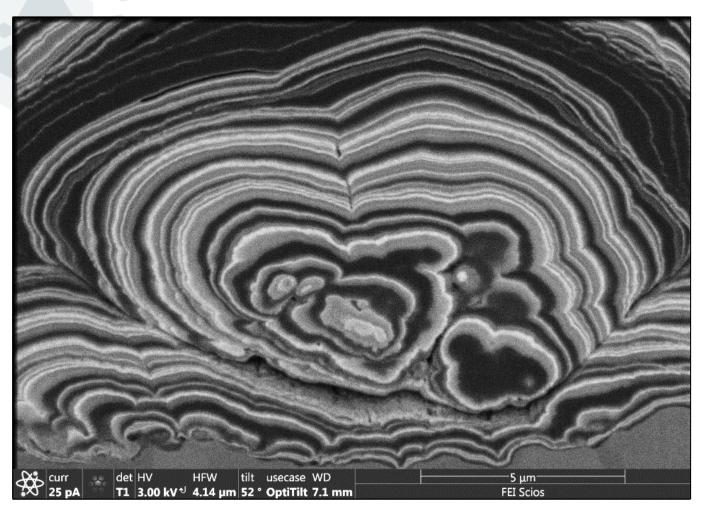
- 1. Emission of secondary electrons and ions
 - FIB Imaging
- 2. Sputtering of substrate atoms
 - FIB milling
- 3. Chemical interactions
 - FIB deposition / enhanced etch

Other effects:

- Ion implantation
- Displacements of atoms in the solid (induced damages)
- Heating

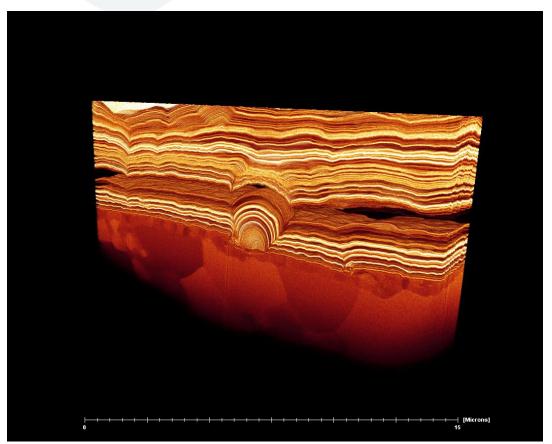


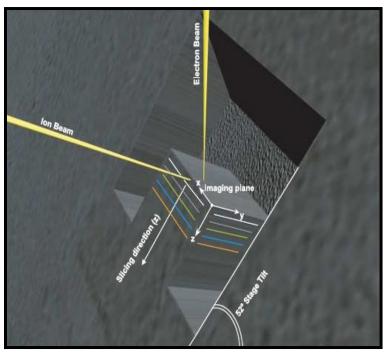
DualBeam™应用之一: 定点观测



l**Sittle lapæSte (inntage strigtjenns étaisattega figio addutaine it ion**oating system due to the multilayer structure of the particle γe.

DualBeam™应用之二:获取三维结构信息 (图形,元素,晶体取向)

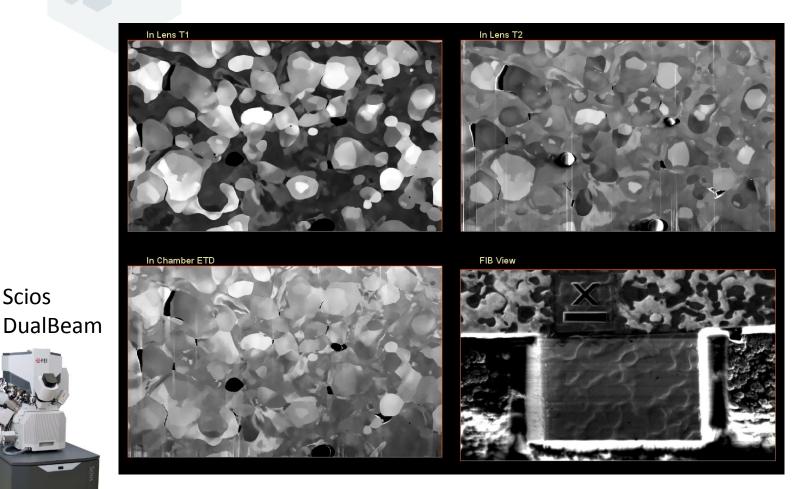






DualBeam™应用之二: 获取三维结构信息

Tips: 多探头同时成像

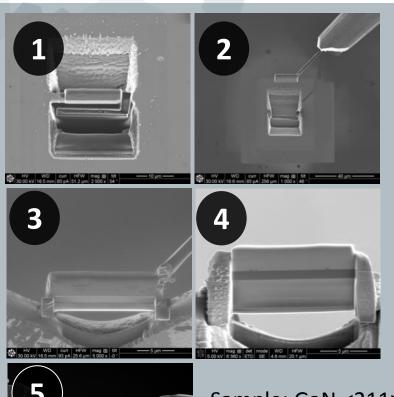




rer. Resolve.

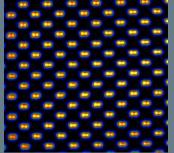
Scios

DualBeam™应用之三: TEM 样品制备



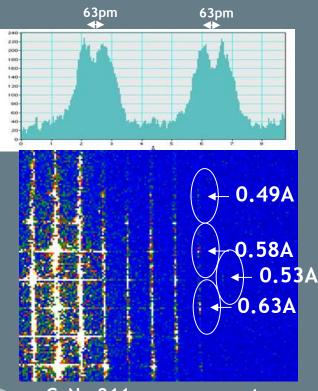
Sample: GaN <211>

Z contrast image (raw data)



Z contrast image (filtered)

STEM Resolution Measured with the TEAM 0.5 Column



GaN <211> power spectrum transfers till 49pm

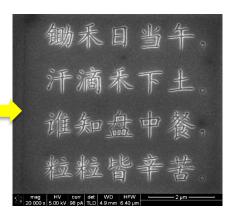
Preparation method:

- In-situ lift-out in Helios NanoLab
- final polishing performed using 1kV FIB
- Total preparation time: 1 hour including lift out



DualBeam™应用之四: 纳米原型制备

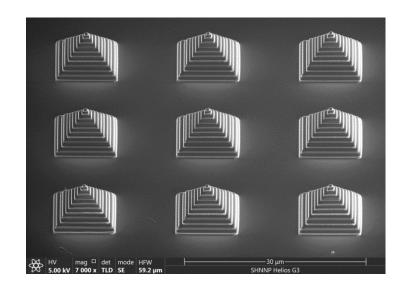
锄禾日当午, 汗滴禾下土。 谁知盘中餐, 粒粒皆辛苦。



(a) Bitmap of poem

(b) Poem fabricated by FIB

Nano Chinese poem fabricated by FIBM. (F. Z. Fang et al. CIRP Annals - Manufacturing Technology 59 (2010) 543–546)



纳米金字塔

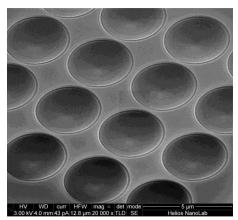


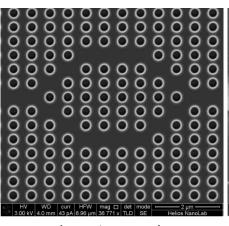
纳米原型制备: Prototyping with NanoBuilderTM

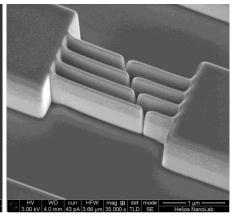


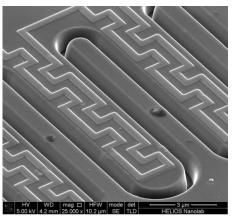
FIB作为微纳米加工手段的优势

- Faster and cheaper, because only very few steps involved
- Flexible many materials can be milled or deposited in the same tool
- Wide feature size from mm to a few nm
- Enables patterning in 3D









Negative microlenses

Photonics crystals

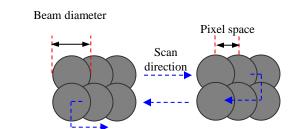
Optical nano cantilevers

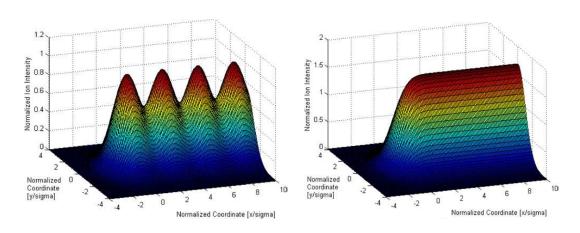
Nanofluidic device



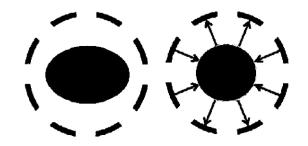
FIB加工的重要参数

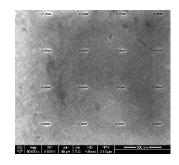
Beam overlap

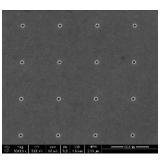




Beam astigmatism





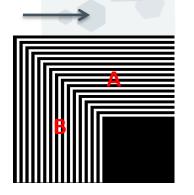


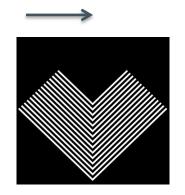
(F. Z. Fang et al. CIRP Annals - Manufacturing Technology 59 (2010) 543–546)

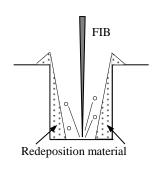


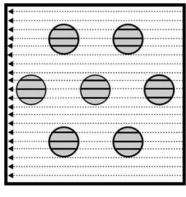
FIB加工的重要参数

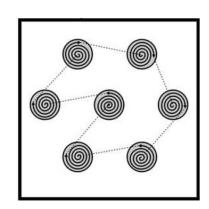
Mill direction

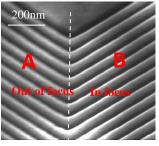




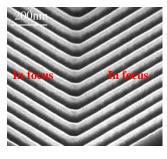




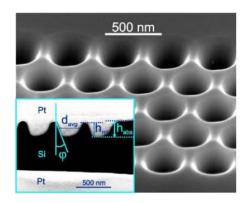


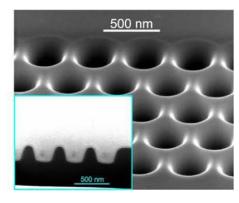






(b) Bitmap of V shape mask





The effect of slit orientation on the FIBDW process. (F. Z. Fang et al. CIRP Annals - Manufacturing Technology 59 (2010) 543–546)

SEM images of comparing 250 nm diameter holes with 440 nm pitch milled into bulk silicon using different FIB scanning strategies. (Hopman et al. Nanotechnology 2007;18:195305.)

FIB加工的重要参数

Dwell time 相同剂量! b 0.40 Sputtering Yield (µm³/nC) 0.35 0.30 0.25 0.20 0.15 100 200 300 400 500 600 700 5 µm Scan Speed (nm/s)

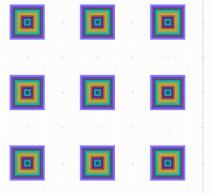
SEM image of FIB patterning as a function of dwell time on the amorphous Ni78B14Si8 substrate. The scan speed was varied by varying the scan loops from 1 to 14 with constant beam exposure time of 90 s: results of (a) milled trenches and (b) Sputtering yields.

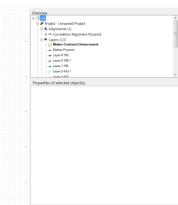
Ref: Li W etc. Appl Surf Sci 2007;253:5404

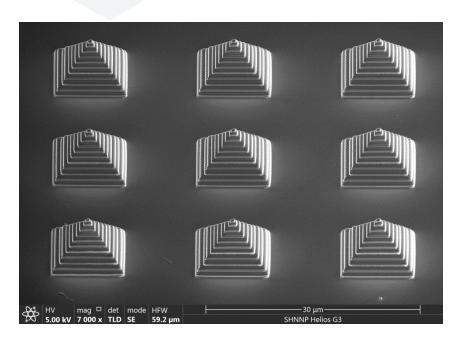


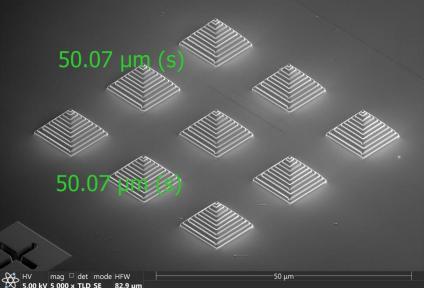
Deposition Pyramid

Micro Pyramid Array Area: 50um*50um



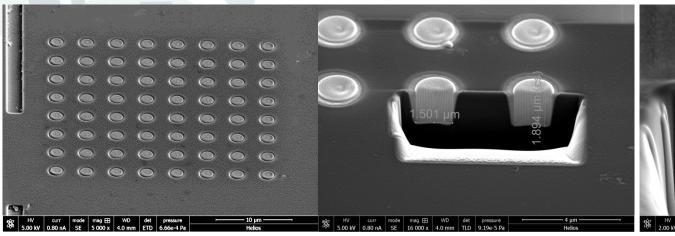


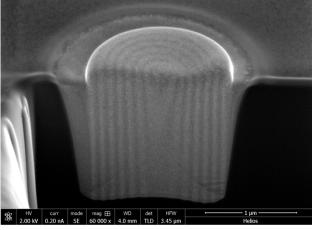


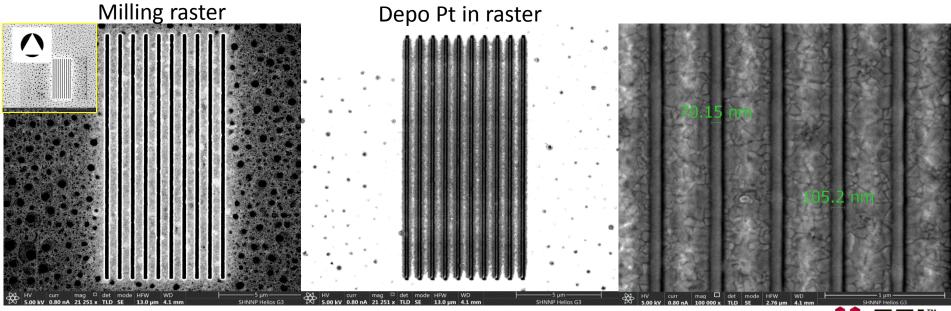




FIB Milling + Deposition(材料置换)



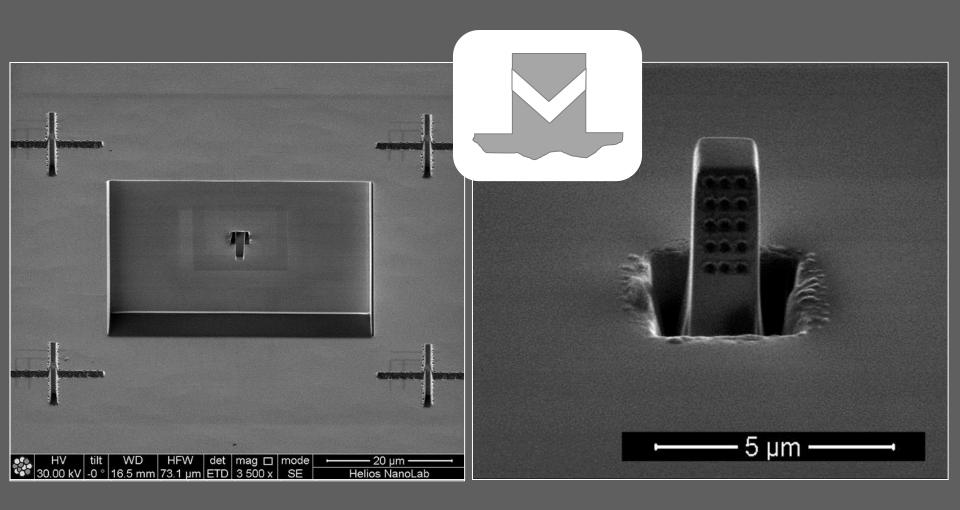




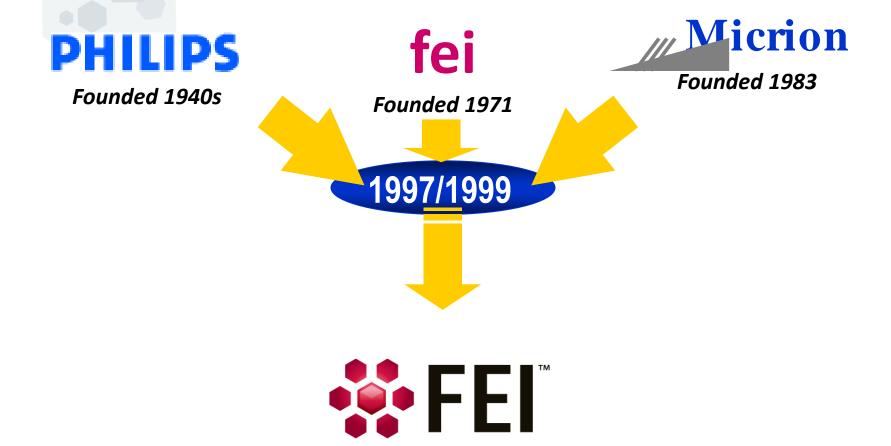


NanoBuilder 自动化加工声学器件

样品台的旋转+倾斜



FEI公司的发展历史





Thank you Q&A

